Accession number:20114214440179

Title:Near-net shaping of single-crystal silicon for optical lens by one-shot pressing at temperature just below silicon melting point and its demonstration of optical properties

Authors: Morishita, Kohei (1); Nakajima, Kazuo (1); Fujii, Takashi (2); Shiinoki, Masakazu (3)

Author affiliation:(1) Department of Socio-Environmental Energy Science, Kyoto University,

Kyoto 606-8501, Japan; (2) Murata Manufacturing Co., Ltd., Nagaokakyo, Kyoto 617-8555,

Japan; (3) OMRON Corporation, Yasu, Shiga 520-2362, Japan

Corresponding author: Morishita, K.(k-morishita@energy.kyoto-u.ac.jp)

Source title: Applied Physics Express

Abbreviated source title: Appl. Phys. Express

Volume:4 Issue:10

Issue date:October 2011 Publication year:2011 Article number:106501 Language:English

ISSN:18820778 E-ISSN:18820786

Document type:Journal article (JA)

Publisher: Japan Society of Applied Physics, 1-12-3 Kudan-Kita,k Chiyoda-ku, Tokyo, 102, Japan Abstract: Silicon is brittle and easily cracks even under a small load. The difficulty in shaping silicon has prevented breakthroughs in the mass production of silicon lenses for terahertz and infrared technology. We developed a novel method of deforming bulk single-crystal silicon into the required shape by one-shot pressing and realized the near-net shaping of silicon into a plano-convex shape with the curvature radius $R=7.5\,$ mm. The crystallographic quality of the obtained lens was improved by primary recrystallization. By packaging it into a practical sensor module, the suitability of the lens for practical application was demonstrated.

Number of references:24